TEXAS INSTRUMENTS

INA219

Zerø-Drift, Bi-Directional
CURRENT/POWER MONITOR with I^{2}C™ Interface

FEATURES

- **SENSES BUS VOLTAGES FROM 0V TO +26V**
- **REPORTS CURRENT, VOLTAGE, AND POWER**
- **16 PROGRAMMABLE ADDRESSES**
- **HIGH ACCURACY: 1% (Max) OVER TEMPERATURE**
- **FILTERING OPTIONS**
- **CALIBRATION REGISTERS**
- **SOT23-8 AND SO-8 PACKAGES**

APPLICATIONS

- **SERVERS**
- **TELECOM EQUIPMENT**
- **NOTEBOOK COMPUTERS**
- **POWER MANAGEMENT**
- **BATTERY CHARGERS**
- **WELDING EQUIPMENT**
- **POWER SUPPLIES**
- **TEST EQUIPMENT**

DESCRIPTION

The INA219 is a high-side current shunt and power monitor with an I^{2}C interface. The INA219 monitors both shunt drop and supply voltage, with programmable conversion times and filtering. A programmable calibration value, combined with an internal multiplier, enables direct readouts in amperes. An additional multiplying register calculates power in watts. The I^{2}C interface features 16 programmable addresses.

The INA219 senses across shunts on buses that can vary from 0V to 26V. The device uses a single +3V to +5.5V supply, drawing a maximum of 1mA of supply current. The INA219 operates from −40°C to +125°C.

RELATED PRODUCTS

DESCRIPTION	DEVICE
Current/Power Monitor with Watchdog, Peak-Hold, and Fast Comparator Functions	INA209
Zerø-Drift, Low-Cost, Analog Current Shunt Monitor Series in Small Package	INA210-INA214
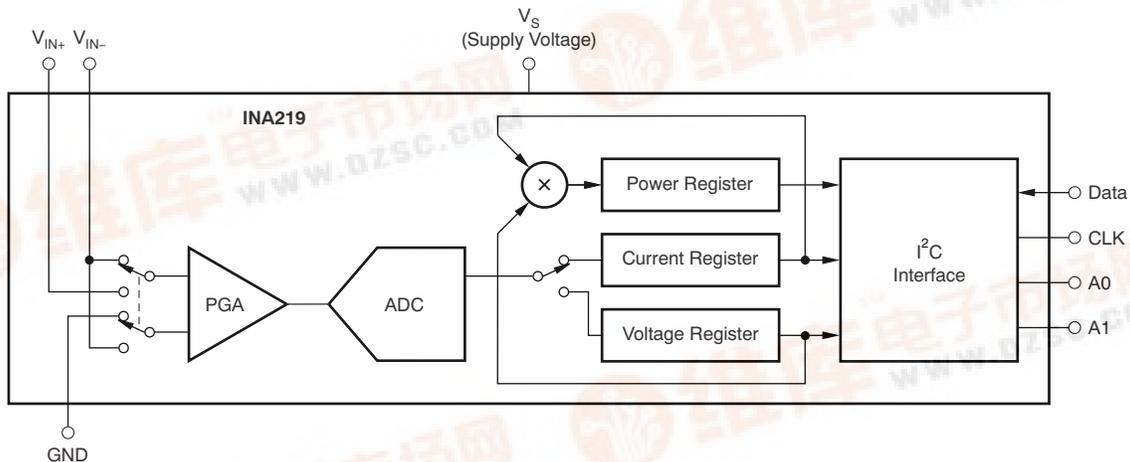
INA219

TEXAS INSTRUMENTS

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION[1]

PRODUCT	PACKAGE-LEAD	PACKAGE DESIGNATOR	PACKAGE MARKING
INA219	SO-8	D	I219A
	SOT23-8	DCN	A219

(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

ABSOLUTE MAXIMUM RATINGS[1]

Over operating free-air temperature range (unless otherwise noted).

		INA219	UNIT
Supply Voltage, V_S		6	V
Analog Inputs, V_{IN+}, V_{IN-}	Differential $(V_{IN+}) - (V_{IN-})$ [2]	−26 to +26	V
	Common-Mode	-0.3 to +26	V
SDA		GND − 0.3 to +6	V
SCL		GND − 0.3 to V_S + 0.3	V
Input Current Into Any Pin		5	mA
Open-Drain Digital Output Current		10	mA
Operating Temperature		−40 to +125	°C
Storage Temperature		−40 to +150	°C
Junction Temperature		+150	°C
ESD Ratings	Human Body Model	4000	V
	Charged-Device Model	750	V
	Machine Model (MM)	200	V

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
(2) V_{IN+} and V_{IN-} may have a differential voltage of −26V to +26V; however, the voltage at these pins must not exceed the range −0.3V to +26V.

ELECTRICAL CHARACTERISTICS: V_S = +3.3V

Boldface limits apply over the specified temperature range, $T_A = -25°C$ to +85°C.

At $T_A = +25°C$, $V_{IN+} = 12V$, $V_{SENSE} = (V_{IN+} - V_{IN-}) = 32mV$, PGA = ÷ 1, and BRNG[1] = 1, unless otherwise noted.

PARAMETER		TEST CONDITIONS	INA219			UNIT
			MIN	TYP	MAX	
INPUT						
Full-Scale Current Sense (Input) Voltage Range		PGA = ÷ 1	0		±40	mV
		PGA = ÷ 2	0		±80	mV
		PGA = ÷ 4	0		±160	mV
		PGA = ÷ 8	0		±320	mV
Bus Voltage (Input Voltage) Range[2]		BRNG = 1	0		32	V
		BRNG = 0	0		16	V
Common-Mode Rejection	CMRR	V_{IN+} = 0V to 26V	100	120		dB
Offset Voltage, RTI[3]	V_{OS}	PGA = ÷ 1		±10	±100	µV
		PGA = ÷ 2		±20	±125	µV
		PGA = ÷ 4		±30	±150	µV
		PGA = ÷ 8		±40	±200	µV
vs Temperature				**0.1**		**µV/°C**
vs Power Supply	PSRR	V_S = 3V to 5.5V		10		µV/V
Current Sense Gain Error				±40		m%
vs Temperature				**10**		**ppm/°C**
Input Impedance		Active Mode				
V_{IN+} Pin				20		µA
V_{IN-} Pin				20 ‖ 320		µA ‖ kΩ
Input Leakage[4]		Power-Down Mode				
V_{IN+} Pin				0.1	±0.5	µA
V_{IN-} Pin				0.1	±0.5	µA
DC ACCURACY						
ADC Basic Resolution				12		Bits
1 LSB Step Size						
Shunt Voltage				10		µV
Bus Voltage				4		mV
Current Measurement Error				±0.2	±0.5	%
over Temperature					**±1**	**%**
Bus Voltage Measurement Error				±0.2	±0.5	%
over Temperature					**±1**	**%**
Differential Nonlinearity				±0.1		LSB
ADC TIMING						
ADC Conversion Time		12-Bit		532	586	µs
		11-Bit		276	304	µs
		10-Bit		148	163	µs
		9-Bit		84	93	µs
Minimum Convert Input Low Time			4			µs

(1) BRNG is bit 13 of the Configuration Register.
(2) This parameter only expresses the full-scale range of the ADC scaling. In no event should more than 26V be applied to this device.
(3) Referred-to-input (RTI).
(4) Input leakage is positive (current flowing into the pin) for the conditions shown at the top of the table. Negative leakage currents can occur under different input conditions.

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ELECTRICAL CHARACTERISTICS: V_S = +3.3V (continued)

Boldface limits apply over the specified temperature range, T_A **= −25°C to +85°C.**

At T_A = +25°C, V_{IN+} = 12V, V_{SENSE} = (V_{IN+} − $V_{IN−}$) = 32mV, PGA = ÷ 1, and BRNG = 1, unless otherwise noted.

PARAMETER	TEST CONDITIONS	INA219			UNIT
		MIN	TYP	MAX	
SMBus					
SMBus Timeout[5]			28	35	ms
DIGITAL INPUTS **(SDA as Input, SCL, A0, A1)**					
Input Capacitance			3		pF
Leakage Input Current	$0 ≤ V_{IN} ≤ V_S$		0.1	1	µA
Input Logic Levels:					
V_{IH}		0.7 (V_S)		6	V
V_{IL}		−0.3		0.3 (V_S)	V
Hysteresis			500		mV
OPEN-DRAIN DIGITAL OUTPUTS (SDA)					
Logic '0' Output Level	I_{SINK} = 3mA		0.15	0.4	V
High-Level Output Leakage Current	V_{OUT} = V_S		0.1	1	µA
POWER SUPPLY					
Operating Supply Range		+3		+5.5	V
Quiescent Current			0.7	1	mA
Quiescent Current, Power-Down Mode			6	15	µA
Power-On Reset Threshold			2		V
TEMPERATURE RANGE					
Specified Temperature Range		−25		+85	°C
Operating Temperature Range		−40		+125	°C
Thermal Resistance[6] $θ_{JA}$					
SOT23-8			142		°C/W
SO-8			120		°C/W

(5) SMBus timeout in the INA219 resets the interface any time SCL or SDA is low for over 28ms.

(6) $θ_{JA}$ value is based on JEDEC low-K board.

PIN CONFIGURATIONS

DCN PACKAGE
SOT23-8
(Top View)

V_{IN+}	1		8	A1
V_{IN-}	2		7	A0
GND	3		6	SDA
V_S	4		5	SCL

D PACKAGE
SO-8
(Top View)

A1	1		8	V_{IN+}
A0	2		7	V_{IN-}
SDA	3		6	GND
SCL	4		5	V_S

PIN DESCRIPTIONS: SOT23-8

SOT23-8 (DCN)		
PIN NO	NAME	DESCRIPTION
1	V_{IN+}	Positive differential shunt voltage. Connect to positive side of shunt resistor.
2	V_{IN-}	Negative differential shunt voltage. Connect to negative side of shunt resistor. Bus voltage is measured from this pin to ground.
3	GND	Ground.
4	V_S	Power supply, 3V to 5.5V.
5	SCL	Serial bus clock line.
6	SDA	Serial bus data line.
7	A0	Address pin. Table 1 shows pin settings and corresponding addresses.
8	A1	Address pin. Table 1 shows pin settings and corresponding addresses.

PIN DESCRIPTIONS: SO-8

SO-8 (D)		
PIN NO	NAME	DESCRIPTION
1	A1	Address pin. Table 1 shows pin settings and corresponding addresses.
2	A0	Address pin. Table 1 shows pin settings and corresponding addresses.
3	SDA	Serial bus data line.
4	SCL	Serial bus clock line.
5	V_S	Power supply, 3V to 5.5V.
6	GND	Ground.
7	V_{IN-}	Negative differential shunt voltage. Connect to negative side of shunt resistor. Bus voltage is measured from this pin to ground.
8	V_{IN+}	Positive differential shunt voltage. Connect to positive side of shunt resistor.

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TYPICAL CHARACTERISTICS

At T_A = +25°C, V_{IN+} = 12V, V_{SENSE} = (V_{IN+} − V_{IN-}) = 32mV, PGA = ÷ 1, and BRNG = 1, unless otherwise noted.

FREQUENCY RESPONSE

Figure 1.

ADC SHUNT OFFSET vs TEMPERATURE

Figure 2.

ADC SHUNT GAIN ERROR vs TEMPERATURE

Figure 3.

ADC BUS VOLTAGE OFFSET vs TEMPERATURE

Figure 4.

ADC BUS GAIN ERROR vs TEMPERATURE

Figure 5.

INTEGRAL NONLINEARITY vs INPUT VOLTAGE
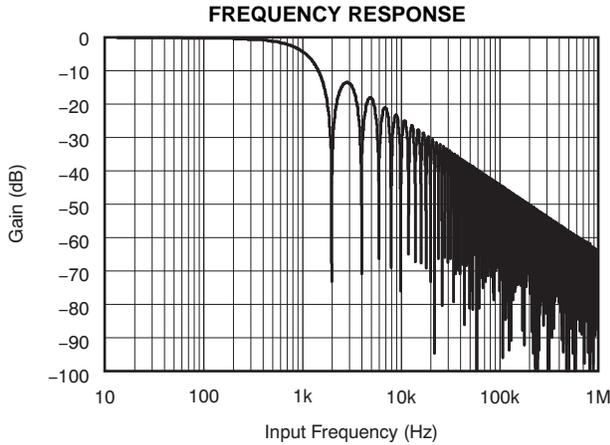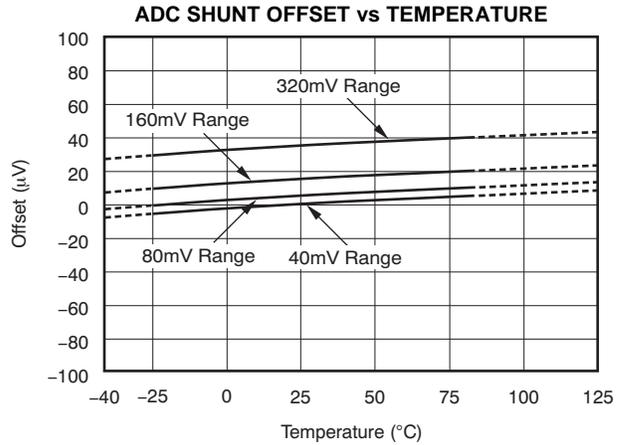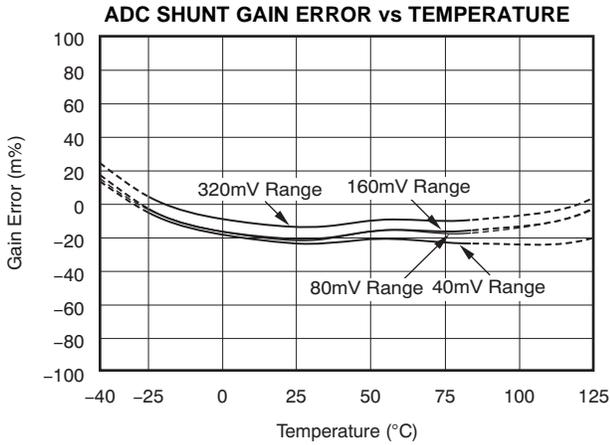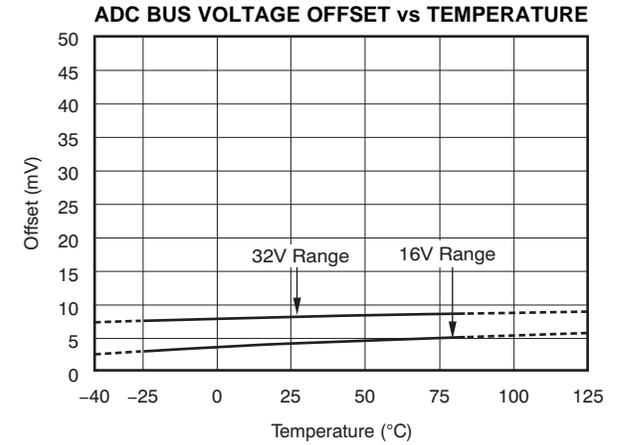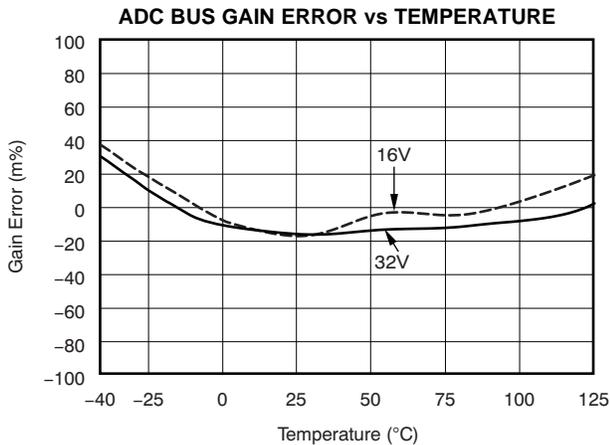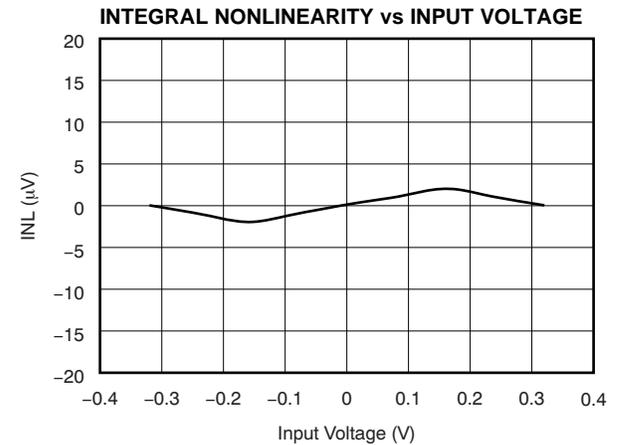
Figure 6.

TYPICAL CHARACTERISTICS (continued)

At T_A = +25°C, V_{IN+} = 12V, V_{SENSE} = (V_{IN+} − $V_{IN−}$) = 32mV, PGA = ÷ 1, and BRNG = 1, unless otherwise noted.

INPUT CURRENTS WITH LARGE DIFFERENTIAL VOLTAGES
(V_{IN+} at 12V, Sweep of $V_{IN−}$)
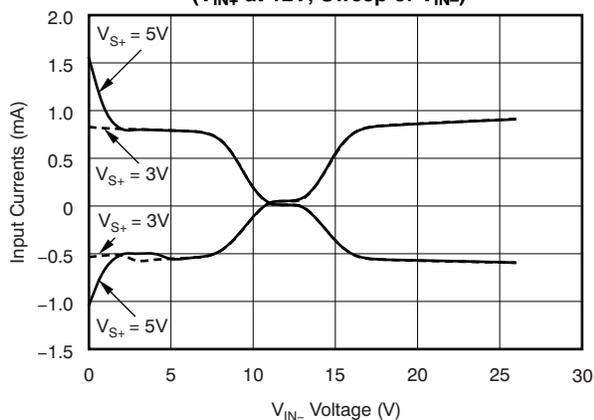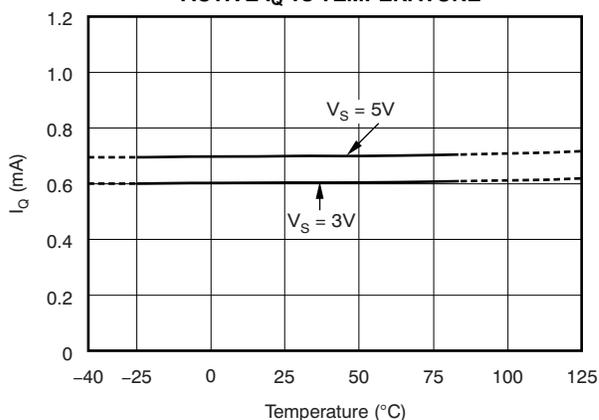

Figure 7.

ACTIVE I_Q vs TEMPERATURE

Figure 8.

SHUTDOWN I_Q vs TEMPERATURE
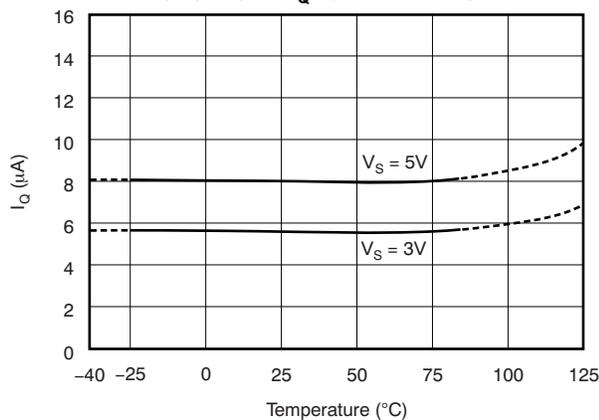
Figure 9.

ACTIVE I_Q vs I²C CLOCK FREQUENCY
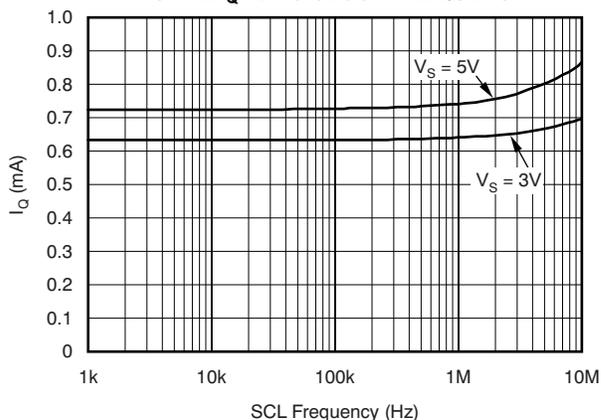
Figure 10.

SHUTDOWN I_Q vs I²C CLOCK FREQUENCY

Figure 11.

INA219

REGISTER BLOCK DIAGRAM

NOTES:
(1) Read-only
(2) Read/write
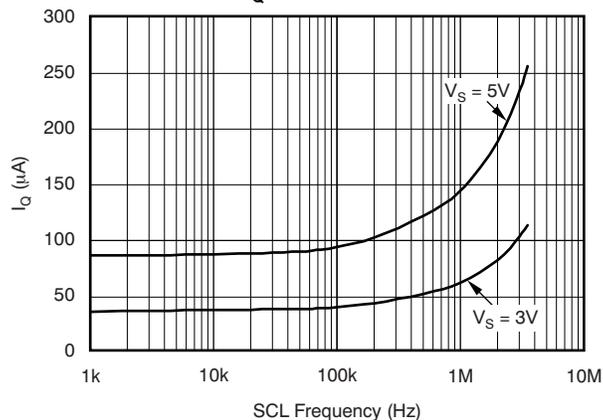
Figure 12. INA219 Register Block Diagram

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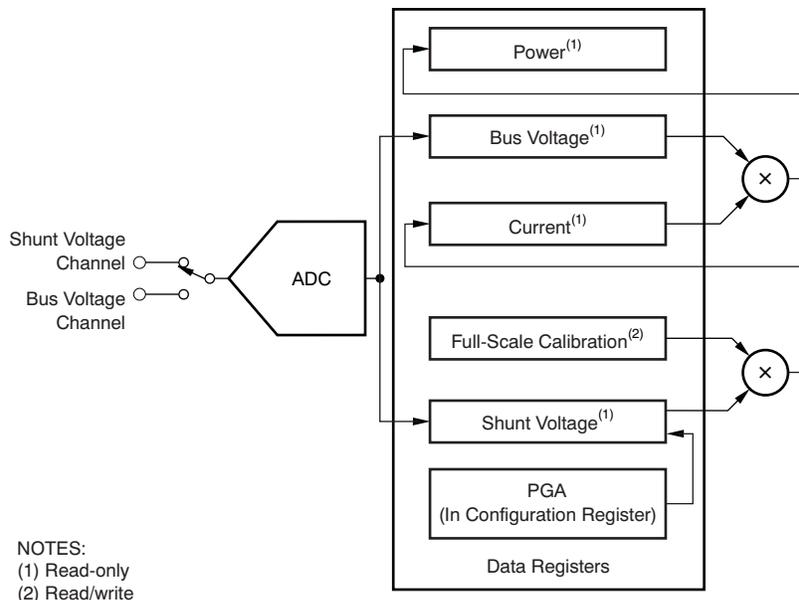
APPLICATION INFORMATION

The INA219 is a digital current-shunt monitor with an I²C and SMBus-compatible interface. It provides digital current, voltage, and power readings necessary for accurate decision-making in precisely-controlled systems. Programmable registers allow flexible configuration for measurement resolution, and continuous-versus-triggered operation. Detailed register information appears at the end of this data sheet, beginning with Table 2. See the Register Block Diagram for a block diagram of the INA219.

INA219 TYPICAL APPLICATION

Figure 13 shows a typical application circuit for the INA219. Use a 0.1µF ceramic capacitor for power-supply bypassing, placed as closely as possible to the supply and ground pins.

The input filter circuit consisting of R_{F1}, R_{F2}, and C_F is not necessary in most applications. If the need for filtering is unknown, reserve board space for the components and install 0Ω resistors unless a filter is needed. See the *Filtering and Input Considerations* section.

The pull-up resistors shown on the SDA and SCL lines are not needed if there are pull-up resistors on these same lines elsewhere in the system. Resistor values shown are typical: consult either the I²C or SMBus specification to determine the acceptable minimum or maximum values.

BUS OVERVIEW

The INA219 offers compatibility with both I²C and SMBus interfaces. The I²C and SMBus protocols are essentially compatible with one another.

The I²C interface is used throughout this data sheet as the primary example, with SMBus protocol specified only when a difference between the two systems is being addressed. Two bidirectional lines, SCL and SDA, connect the INA219 to the bus. Both SCL and SDA are open-drain connections.

The device that initiates the transfer is called a *master*, and the devices controlled by the master are *slaves*. The bus must be controlled by a master device that generates the serial clock (SCL), controls the bus access, and generates START and STOP conditions.

To address a specific device, the master initiates a START condition by pulling the data signal line (SDA) from a HIGH to a LOW logic level while SCL is HIGH. All slaves on the bus shift in the slave address byte on the rising edge of SCL, with the last bit indicating whether a read or write operation is intended. During the ninth clock pulse, the slave being addressed responds to the master by generating an Acknowledge and pulling SDA LOW.

Data transfer is then initiated and eight bits of data are sent, followed by an *Acknowledge* bit. During data transfer, SDA must remain stable while SCL is HIGH. Any change in SDA while SCL is HIGH is interpreted as a START or STOP condition.

Once all data have been transferred, the master generates a STOP condition, indicated by pulling SDA from LOW to HIGH while SCL is HIGH. The INA219 includes a 28ms timeout on its interface to prevent locking up an SMBus.
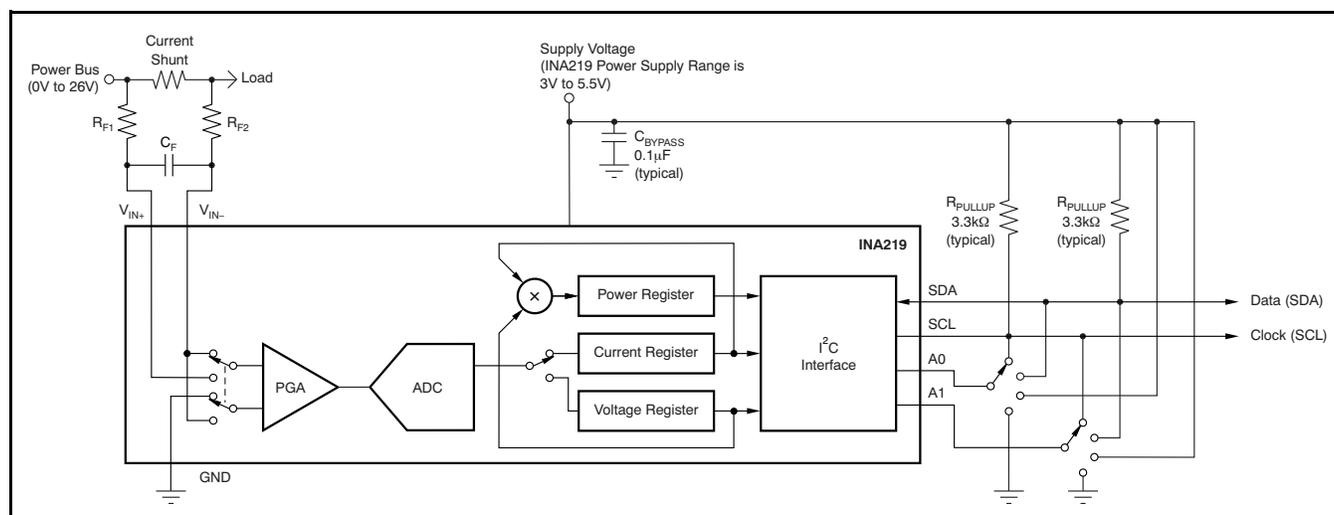

Figure 13. Typical Application Circuit

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Serial Bus Address

To communicate with the INA219, the master must first address slave devices via a slave address byte. The slave address byte consists of seven address bits, and a direction bit indicating the intent of executing a read or write operation.

The INA219 has two address pins, A0 and A1. Table 1 describes the pin logic levels for each of the 16 possible addresses. The state of pins A0 and A1 is sampled on every bus communication and should be set before any activity on the interface occurs. The address pins are read at the start of each communication event.

Table 1. INA219 Address Pins and Slave Addresses

A1	A0	SLAVE ADDRESS
GND	GND	1000000
GND	V_{S+}	1000001
GND	SDA	1000010
GND	SCL	1000011
V_{S+}	GND	1000100
V_{S+}	V_{S+}	1000101
V_{S+}	SDA	1000110
V_{S+}	SCL	1000111
SDA	GND	1001000
SDA	V_{S+}	1001001
SDA	SDA	1001010
SDA	SCL	1001011
SCL	GND	1001100
SCL	V_{S+}	1001101
SCL	SDA	1001110
SCL	SCL	1001111

Serial Interface

The INA219 operates only as a slave device on the I^2C bus and SMBus. Connections to the bus are made via the open-drain I/O lines SDA and SCL. The SDA and SCL pins feature integrated spike suppression filters and Schmitt triggers to minimize the effects of input spikes and bus noise. The INA219 supports the transmission protocol for fast (1kHz to 400kHz) and high-speed (1kHz to 3.4MHz) modes. All data bytes are transmitted most significant byte first.

WRITING TO/READING FROM THE INA219

Accessing a particular register on the INA219 is accomplished by writing the appropriate value to the register pointer. Refer to Table 2 for a complete list of registers and corresponding addresses. The value for the register pointer as shown in Figure 17 is the first byte transferred after the slave address byte with the R/$\overline{W}$ bit LOW. Every write operation to the INA219 requires a value for the register pointer.

Writing to a register begins with the first byte transmitted by the master. This byte is the slave address, with the R/$\overline{W}$ bit LOW. The INA219 then acknowledges receipt of a valid address. The next byte transmitted by the master is the address of the register to which data will be written. This register address value updates the register pointer to the desired register. The next two bytes are written to the register addressed by the register pointer. The INA219 acknowledges receipt of each data byte. The master may terminate data transfer by generating a START or STOP condition.

When reading from the INA219, the last value stored in the register pointer by a write operation determines which register is read during a read operation. To change the register pointer for a read operation, a new value must be written to the register pointer. This write is accomplished by issuing a slave address byte with the R/$\overline{W}$ bit LOW, followed by the register pointer byte. No additional data are required. The master then generates a START condition and sends the slave address byte with the R/$\overline{W}$ bit HIGH to initiate the read command. The next byte is transmitted by the slave and is the most significant byte of the register indicated by the register pointer. This byte is followed by an *Acknowledge* from the master; then the slave transmits the least significant byte. The master acknowledges receipt of the data byte. The master may terminate data transfer by generating a *Not-Acknowledge* after receiving any data byte, or generating a START or STOP condition. If repeated reads from the same register are desired, it is not necessary to continually send the register pointer bytes; the INA219 retains the register pointer value until it is changed by the next write operation.

Figure 14 and Figure 15 show read and write operation timing diagrams, respectively. Note that register bytes are sent most-significant byte first, followed by the least significant byte. Figure 16 shows the timing diagram for the SMBus Alert response operation. Figure 17 illustrates a typical register pointer configuration.
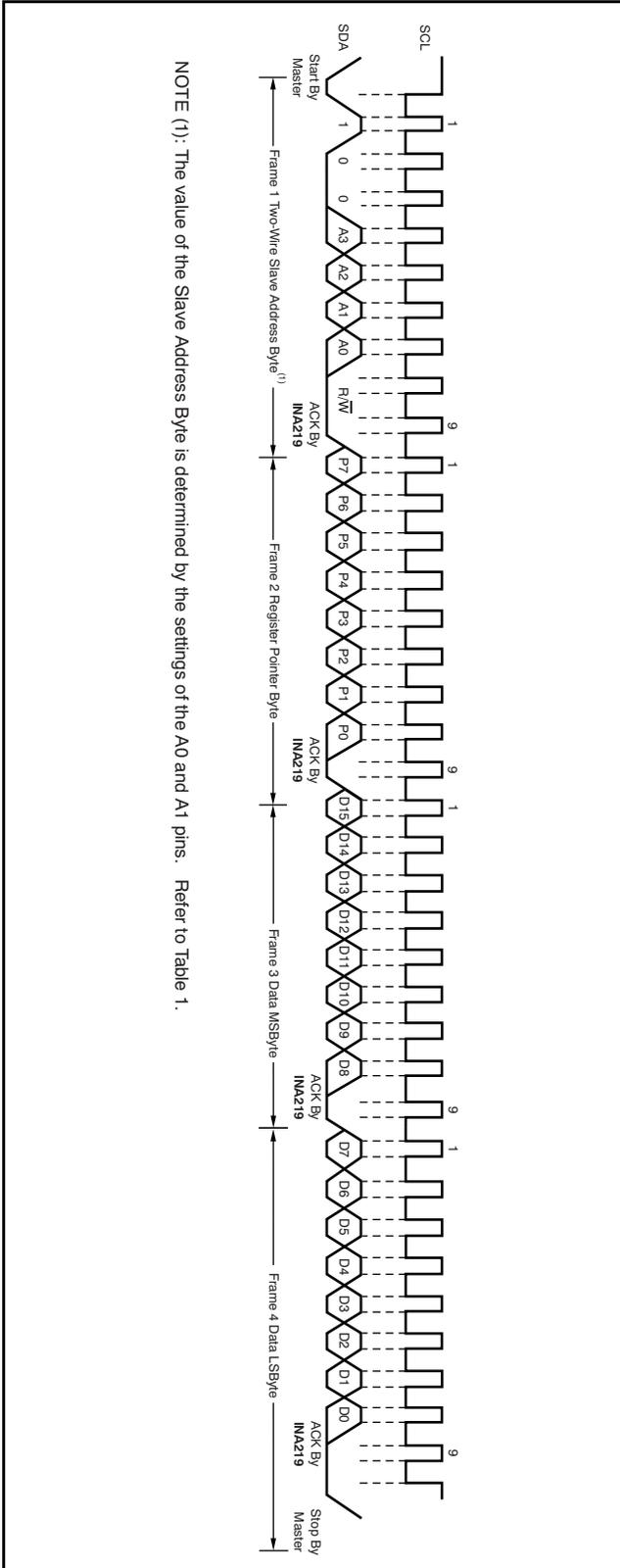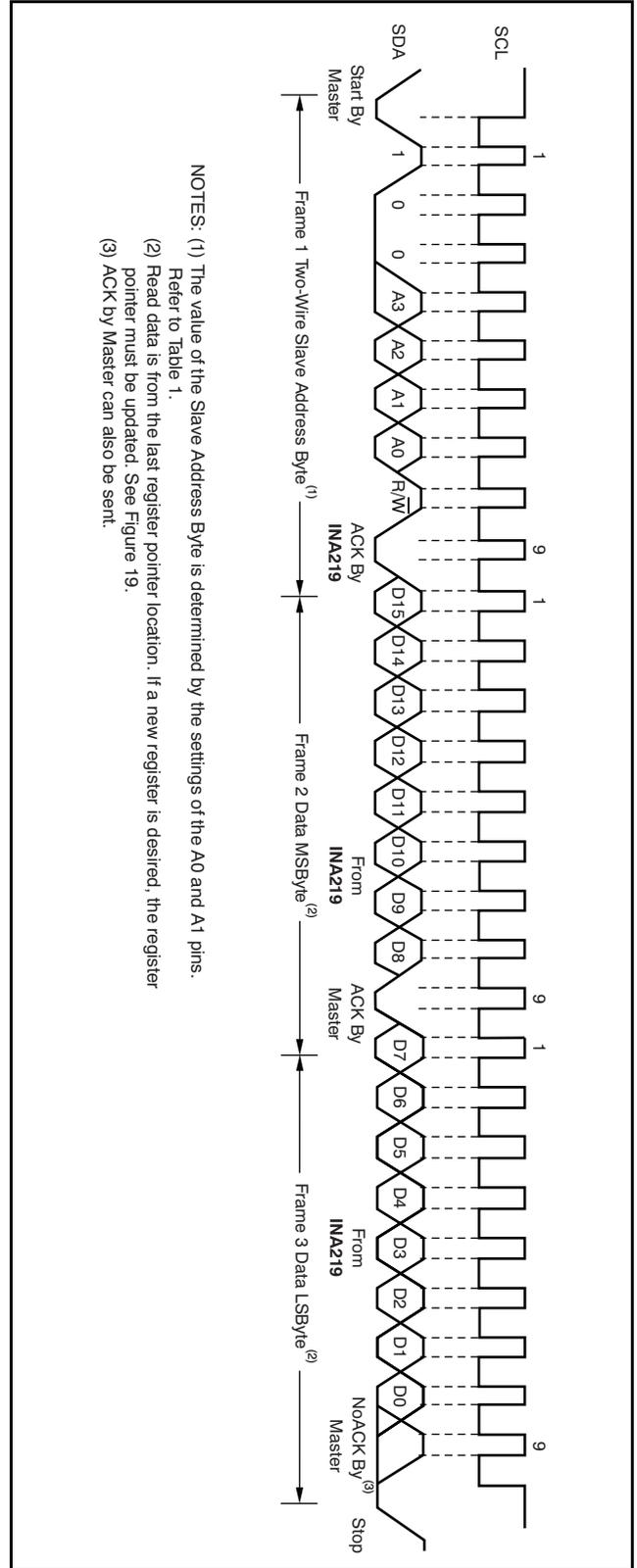
Figure 14. Timing Diagram for Write Word Format

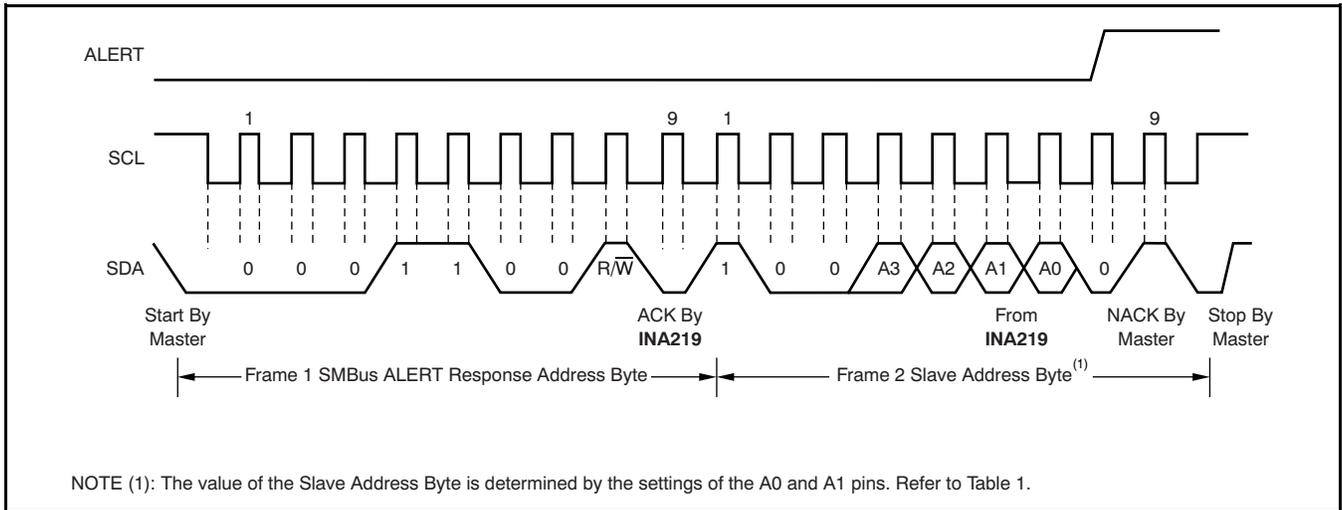**Figure 15. Timing Diagram for Read Word Format**

NOTE (1): The value of the Slave Address Byte is determined by the settings of the A0 and A1 pins.   Refer to Table 1.

NOTES: (1) The value of the Slave Address Byte is determined by the settings of the A0 and A1 pins. Refer to Table 1.
(2) Read data is from the last register pointer location. If a new register is desired, the register pointer must be updated. See Figure 19.
(3) ACK by Master can also be sent.

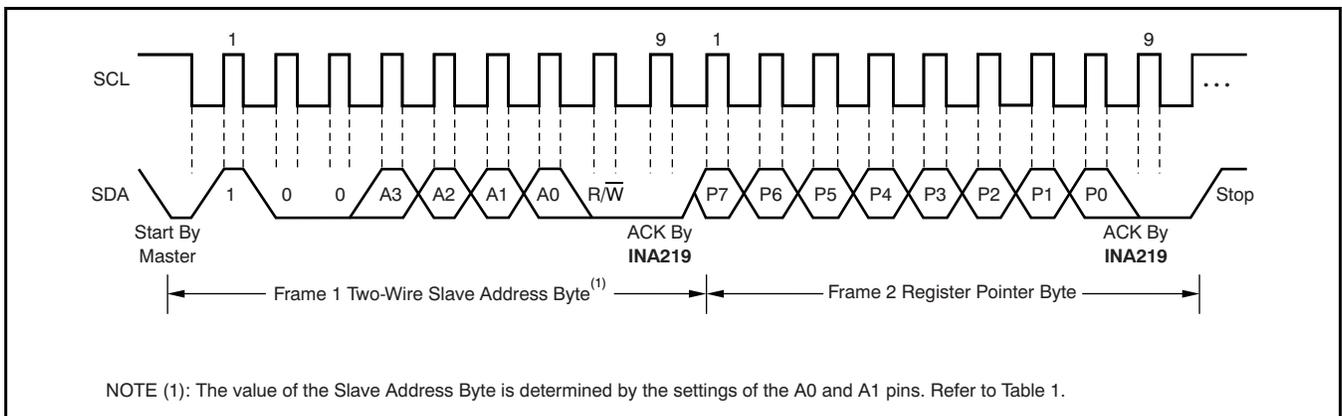**Figure 16. Timing Diagram for SMBus ALERT**

Figure 17. Typical Register Pointer Set

High-Speed I²C Mode

When the bus is idle, both the SDA and SCL lines are pulled high by the pull-up devices. The master generates a start condition followed by a valid serial byte containing High-Speed (HS) master code *00001XXX*. This transmission is made in fast (400kbps) or standard (100kbps) (F/S) mode at no more than 400kbps. The INA219 does not acknowledge the HS master code, but does recognize it and switches its internal filters to support 3.4Mbps operation.

The master then generates a repeated start condition (a repeated start condition has the same timing as the start condition). After this repeated start condition, the protocol is the same as F/S mode, except that transmission speeds up to 3.4Mbps are allowed. Instead of using a stop condition, repeated start conditions should be used to secure the bus in HS-mode. A stop condition ends the HS-mode and switches all the internal filters of the INA219 to support the F/S mode.
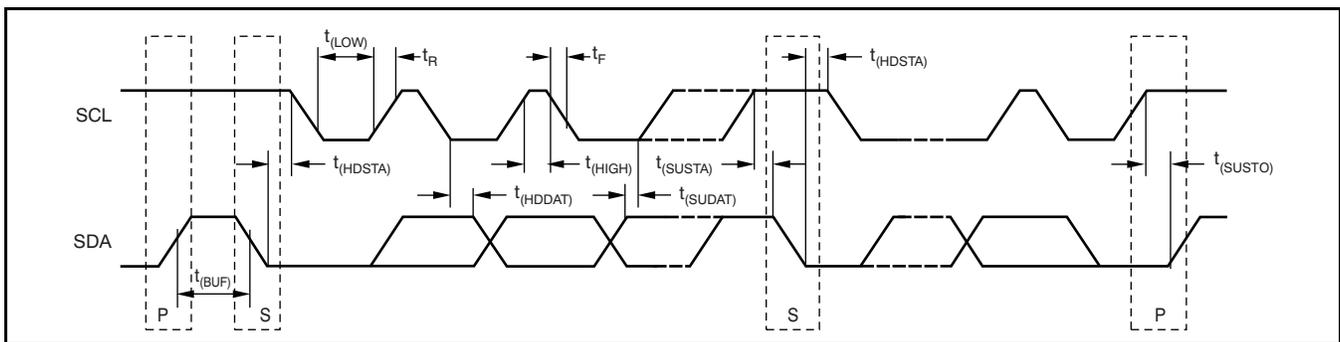

Figure 18. Bus Timing Diagram

Bus Timing Diagram Definitions

PARAMETER		FAST MODE		HIGH-SPEED MODE		UNITS
		MIN	MAX	MIN	MAX	
SCL Operating Frequency	$f_{(SCL)}$	0.001	0.4	0.001	3.4	MHz
Bus Free Time Between STOP and START Condition	$t_{(BUF)}$	600		160		ns
Hold time after repeated START condition. After this period, the first clock is generated.	$t_{(HDSTA)}$	100		100		ns
Repeated START Condition Setup Time	$t_{(SUSTA)}$	100		100		ns
STOP Condition Setup Time	$t_{(SUSTO)}$	100		100		ns
Data Hold Time	$t_{(HDDAT)}$	0		0		ns
Data Setup Time	$t_{(SUDAT)}$	100		10		ns
SCL Clock LOW Period	$t_{(LOW)}$	1300		160		ns
SCL Clock HIGH Period	$t_{(HIGH)}$	600		60		ns
Clock/Data Fall Time	t_F		300		160	ns
Clock/Data Rise Time	t_R		300		160	ns
Clock/Data Rise Time for SCLK ≤ 100kHz	t_R		1000			ns

Power-Up Conditions

Power-up conditions apply to a software reset via the RST bit (bit 15) in the Configuration Register, or the I²C bus General Call Reset.

BASIC ADC FUNCTIONS

The two analog inputs to the INA219, V_{IN+} and $V_{IN−}$, connect to a shunt resistor in the bus of interest. The INA219 is typically powered by a separate supply from +3V to +5.5V. The bus being sensed can vary from 0V to 26V. There are no special considerations for power-supply sequencing (for example, a bus voltage can be present with the supply voltage off, and vice-versa). The INA219 senses the small drop across the shunt for shunt voltage, and senses the voltage with respect to ground from $V_{IN−}$ for the bus voltage. Figure 19 illustrates this operation.

When the INA219 is in the normal operating mode (that is, MODE bits of the Configuration Register are set to '111'), it continuously converts the shunt voltage up to the number set in the shunt voltage averaging function (Configuration Register, SADC bits). The device then converts the bus voltage up to the number set in the bus voltage averaging (Configuration Register, BADC bits). The Mode control in the Configuration Register also permits selecting modes to convert only voltage or current, either continuously or in response to an event (triggered).

All current and power calculations are performed in the background and do not contribute to conversion time; conversion times shown in the Electrical Characteristics table can be used to determine the actual conversion time.

Power-Down mode reduces the quiescent current and turns off current into the INA219 inputs, avoiding any supply drain. Full recovery from Power-Down requires 40µs. ADC Off mode (set by the Configuration Register, MODE bits) stops all conversions.

In triggered mode, the external Convert line becomes active. Convert commands are initiated by taking the Convert line low for a minimum of 4µs. The Convert line may be connected high when unused. Any re-trigger of the Convert line during a conversion is ignored, and the Convert line state is disregarded until the conversion ends. There are several available triggered modes; however, all conversions are performed repeatedly up to the number set in the Averaging function (Configuration Register, BADC and SADC bits).

If the Convert line is held low, writing any of the triggered convert modes into the Configuration Register (even if the desired mode is already programmed into the register) triggers a single-shot conversion.
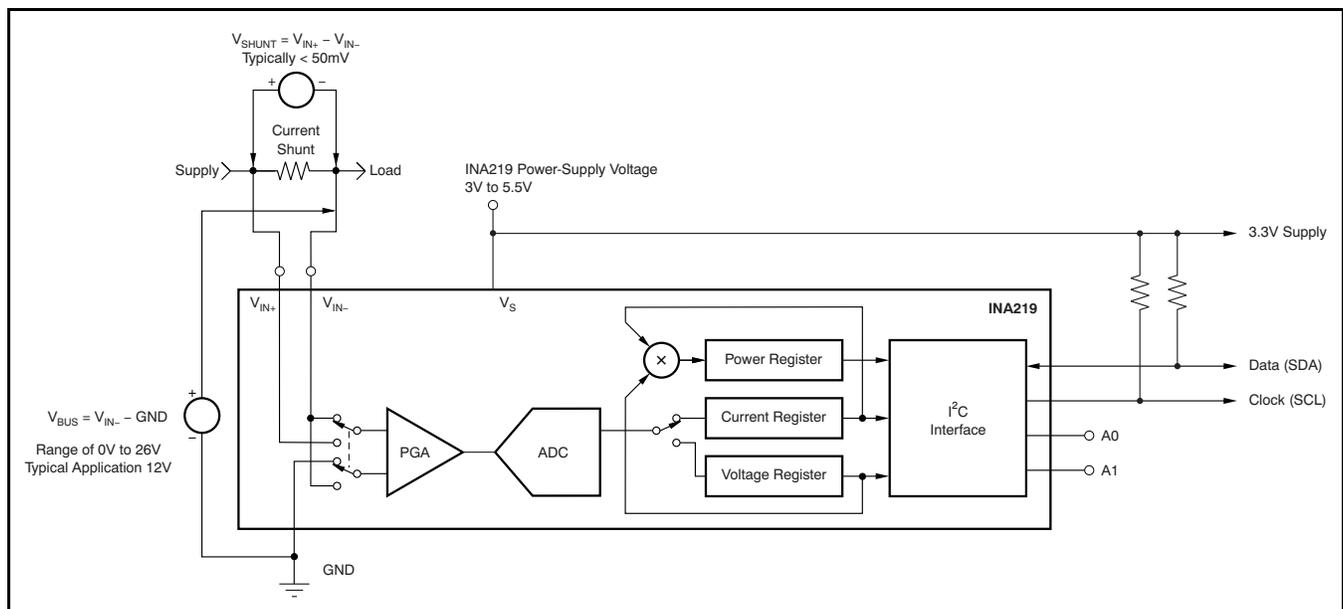

Figure 19. INA219 Configured for Shunt and Bus Voltage Measurement

Although the INA219 can be read at any time, and the data from the last conversion remain available, the Conversion Ready bit (Status Register, CNVR bit) is provided to help co-ordinate one-shot or triggered conversions. The Conversion Ready bit is set after all conversions, averaging, and multiplication operations are complete.

The Conversion Ready bit clears under these conditions:

1. Writing to the Configuration Register, except when configuring the MODE bits for Power Down or ADC off (Disable) modes;
2. Reading the Status Register; or
3. Triggering a single-shot conversion with the Convert pin.

Power Measurement

Current and bus voltage are converted at different points in time, depending on the resolution and averaging mode settings. For instance, when configured for 12-bit and 128 sample averaging, up to 68ms in time between sampling these two values is possible. Again, these calculations are performed in the background and do not add to the overall conversion time.

PGA Function

If larger full-scale shunt voltages are desired, the INA219 provides a PGA function that increases the full-scale range up to 2, 4, or 8 times (320mV). Additionally, the bus voltage measurement has two full-scale ranges: 16V or 32V.

Compatibility with TI Hot Swap Controllers

The INA219 is designed for compatibility with hot swap controllers such the TI TPS2490. The TPS2490 uses a high-side shunt with a limit at 50mV; the INA219 full-scale range of 40mV enables the use of the same shunt for current sensing below this limit. When sensing is required at (or through) the 50mV sense point of the TPS2490, the PGA of the INA219 can be set to ÷2 to provide an 80mV full-scale range.

Filtering and Input Considerations

Measuring current is often noisy, and such noise can be difficult to define. The INA219 offers several options for filtering by choosing resolution and averaging in the Configuration Register. These filtering options can be set independently for either voltage or current measurement.

The internal ADC is based on a delta-sigma (ΔΣ) front-end with a 500kHz (±30%) typical sampling rate. This architecture has good inherent noise rejection; however, transients that occur at or very close to the sampling rate harmonics can cause problems. Because these signals are at 1MHz and higher, they can be dealt with by incorporating filtering at the input of the INA219. The high frequency enables the use of low-value series resistors on the filter for negligible effects on measurement accuracy. In general, filtering the INA219 input is only necessary if there are transients at exact harmonics of the 500kHz (±30%) sampling rate (>1MHz). Filter using the lowest possible series resistance and ceramic capacitor. Recommended values are 0.1μF to 1.0μF. Figure 20 shows the INA219 with an additonal filter added at the input.
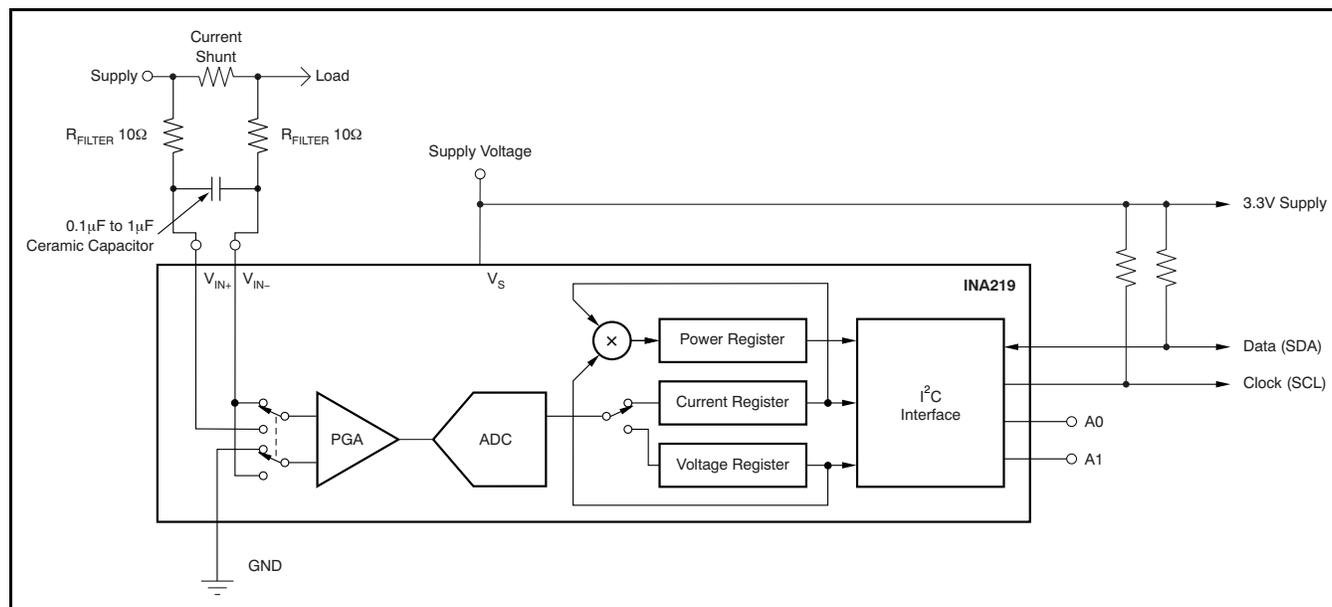

Figure 20. INA219 with Input Filtering

Overload conditions are another consideration for the INA219 inputs. The INA219 inputs are specified to tolerate 26V across the inputs. A large differential scenario might be a short to ground on the load side of the shunt. This type of event can result in full power-supply voltage across the shunt (as long the power supply or energy storage capacitors support it). It must be remembered that removing a short to ground can result in inductive kickbacks that could exceed the 26V differential and common-mode rating of the INA219. Inductive kickback voltages are best dealt with by zener-type transient-absorbing devices (commonly called *transzorbs*) combined with sufficient energy storage capacitance.

In applications that do not have large energy storage electrolytics on one or both sides of the shunt, an input overstress condition may result from an excessive dV/dt of the voltage applied to the input. A hard physical short is the most likely cause of this event, particularly in applications with no large electrolytics present. This problem occurs because an excessive dV/dt can activate the ESD protection in the INA219 in systems where large currents are available. Testing has demonstrated that the addition of 10Ω resistors in series with each input of the INA219 sufficiently protects the inputs against dV/dt failure up to the 26V rating of the INA219. These resistors have no significant effect on accuracy.

Simple Current Shunt Monitor Usage (No Programming Necessary)

The INA219 can be used without any programming if it is only necessary to read a shunt voltage drop and bus voltage with the default 12-bit resolution, 320mV shunt full-scale range (PGA=÷8), 32V bus full-scale range, and continuous conversion of shunt and bus voltage.

Without programming, current is measured by reading the shunt voltage. The Current Register and Power Register are only available if the Calibration Register contains a programmed value.

Programming the INA219

The default power-up states of the registers are shown in the INA219 register descriptions section of this data sheet. These registers are volatile, and if programmed to other than default values, must be re-programmed at every device power-up. Detailed information on programming the Calibration Register specifically is given in the section, *Programming the INA219 Power Measurement Engine*.

PROGRAMMING THE INA219 POWER MEASUREMENT ENGINE

Calibration Register and Scaling

The Calibration Register makes it possible to set the scaling of the Current and Power Registers to whatever values are most useful for a given application. One strategy may be to set the Calibration Register such that the largest possible number is generated in the Current Register or Power Register at the expected full-scale point; this approach yields the highest resolution. The Calibration Register can also be selected to provide values in the Current and Power Registers that either provide direct decimal equivalents of the values being measured, or yield a round LSB number. After these choices have been made, the Calibration Register also offers possibilities for end user system-level calibration, where the value is adjusted slightly to cancel total system error.

Below are two examples for configuring the INA219 calibration. Both examples are written so the information directly relates to the calibration setup found in the INA219EVM software.

Calibration Example 1: Calibrating the INA219 with no possibility for overflow. (Note that the numbers used in this example are the same used with the INA219EVM software as shown in Figure 21.)

1. Establish the following parameters:

    $V_{BUS\_MAX} = 32$

    $V_{SHUNT\_MAX} = 0.32$

    $R_{SHUNT} = 0.5$

2. Using Equation 1, determine the maximum possible current .

$$\text{MaxPossible\_I} = \frac{V_{SHUNT\_MAX}}{R_{SHUNT}}$$

$\text{MaxPossible\_I} = 0.64$

(1)

3. Choose the desired maximum current value. This value is selected based on system expectations.

    $\text{Max\_Expected\_I} = 0.6$

4. Calculate the possible range of current LSBs. To calculate this range, first compute a range of LSBs that is appropriate for the design. Next, select an LSB within this range. Note that the results will have the most resolution when the minimum LSB is selected. Typically, an LSB is selected to be the nearest round number to the minimum LSB value.

$$\text{Minimum\_LSB} = \frac{\text{Max\_Expected\_I}}{32767}$$

$\text{Minimum\_LSB} = 18.311 \times 10^{-6}$

(2)

$$\text{Maximum\_LSB} = \frac{\text{Max\_Expected\_I}}{4096}$$

$\text{Maximum\_LSB} = 146.520 \times 10^{-6}$

(3)

Choose an LSB in the range: Minimum_LSB<Selected_LSB < Maximum_LSB

$\text{Current\_LSB} = 20 \times 10^{-6}$

Note:

This value was selected to be a round number near the Minimum_LSB. This selection allows for good resolution with a rounded LSB.

5. Compute the Calibration Register value using Equation 4:

$$\text{Cal} = \text{trunc}\left[\frac{0.04096}{\text{Current\_LSB} \times R_{SHUNT}}\right]$$

$\text{Cal} = 4096$

(4)

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6. Calculate the Power LSB, using Equation 5. Equation 5 shows a general formula; because the bus voltage measurement LSB is always 4mV, the power formula reduces to the calculated result.

Power_LSB = 20 Current_LSB

$$\text{Power\_LSB} = 400 \times 10^{-6}$$

(5)

7. Compute the maximum current and shunt voltage values (before overflow), as shown by Equation 6 and Equation 7. Note that both Equation 6 and Equation 7 involve an *If - then* condition:

Max_Current = Current_LSB × 32767

$$\text{Max\_Current} = 0.65534$$

(6)

    If Max_Current ≥ Max Possible_I then

        Max_Current_Before_Overflow = MaxPossible_I

    Else

        Max_Current_Before_Overflow = Max_Current

    End If

    (Note that Max_Current is greater than MaxPossible_I in this example.)

    Max_Current_Before_Overflow = 0.64 (Note: This result is displayed by software as seen in Figure 21.)

$$\text{Max\_ShuntVoltage} = \text{Max\_Current\_Before\_Overflow} \times R_{SHUNT}$$

$$\text{Max\_ShuntVoltage} = 0.32$$

(7)

      If Max_ShuntVoltage ≥ V_{SHUNT_MAX}

        Max_ShuntVoltage_Before_Overflow = V_{SHUNT_MAX}

      Else

        Max_ShuntVoltage_Before_Overflow= Max_ShuntVoltage

      End If

      (Note that Max_ShuntVoltage is greater than V_{SHUNT_MAX} in this example.)

      Max_ShuntVoltage_Before_Overflow = 0.32 (Note: This result is displayed by software as seen in Figure 21.)

8. Compute the maximum power with Equation 8.

$$\text{MaximumPower} = \text{Max\_Current\_Before\_Overflow} \times V_{BUS\_MAX}$$

MaximumPower = 20.48

(8)

9. (Optional second Calibration step.) Compute corrected full-scale calibration value based on measured current.

    INA219_Current = 0.63484

    MeaShuntCurrent = 0.55

$$\text{Corrected\_Full\_Scale\_Cal} = \text{trunc}\left[\frac{\text{Cal} \times \text{MeasShuntCurrent}}{\text{INA219\_Current}}\right]$$

Corrected_Full_Scale_Cal = 3548

(9)

Figure 21 illustrates how to perform the same procedure discussed in this example using the automated INA219EVM software. Note that the same numbers used in the nine-step example are used in the software example in Figure 21. Also note that Figure 21 illustrates which results correspond to which step (for example, the information entered in Step 1 is enclosed in a box in Figure 21 and labeled).
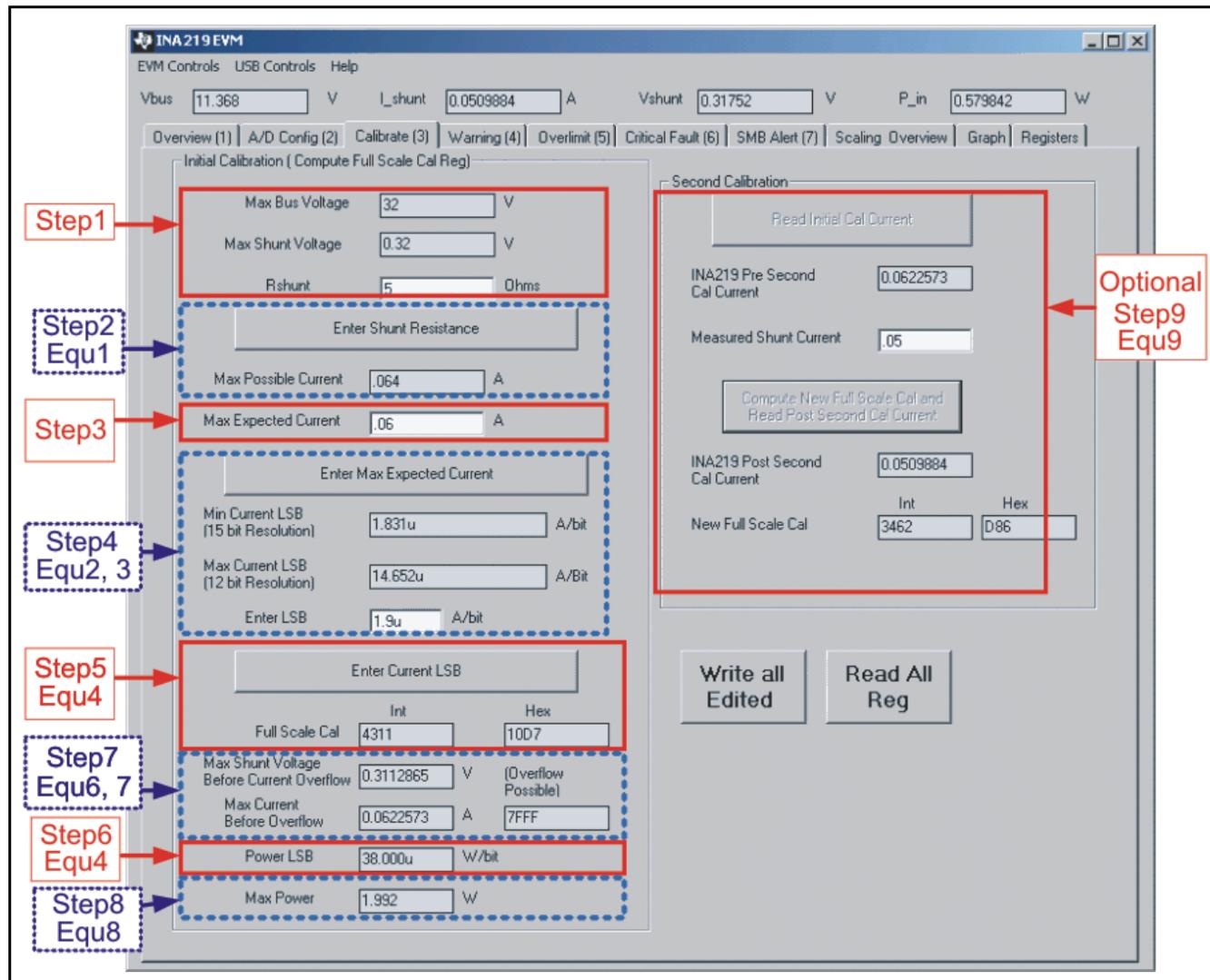
Figure 21. INA219 Calibration Sofware Automatically Computes Calibration Steps 1-9

Calibration Example 2 (Overflow Possible)

This design example uses the nine-step procedure for calibrating the INA219 where overflow is possible. Figure 22 illustrates how the same procedure is performed using the automated INA219EVM software. Note that the same numbers used in the nine-step example are used in the software example in Figure 22. Also note that Figure 22 illustrates which results correspond to which step (for example, the information entered in Step 1 is circled in Figure 22 and labeled).

1. Establish the following parameters:

    $V_{BUS\_MAX} = 32$

    $V_{SHUNT\_MAX} = 0.32$

    $R_{SHUNT} = 5$

2. Determine the maximum possible current using Equation 10:

$$MaxPossible\_I = \frac{V_{SHUNT\_MAX}}{R_{SHUNT}}$$

$$MaxPossible\_I = 0.064$$

(10)

3. Choose the desired maximum current value: Max_Expected_I, ≤ MaxPossible_I. This value is selected based on system expectations.

    $Max\_Expected\_I = 0.06$

4. Calculate the possible range of current LSBs. This calculation is done by first computing a range of LSB's that is appropriate for the design. Next, select an LSB withing this range. Note that the results will have the most resolution when the minimum LSB is selected. Typically, an LSB is selected to be the nearest round number to the minimum LSB.

$$Minimum\_LSB = \frac{Max\_Expected\_I}{32767}$$

$$Minimum\_LSB = 1.831 \times 10^{-6}$$

(11)

$$Maximum\_LSB = \frac{Max\_Expected\_I}{4096}$$

$$Maximum\_LSB = 14.652 \times 10^{-6}$$

(12)

   Choose an LSB in the range: Minimum_LSB<Selected_LSB<Maximum_LSB

   $Current\_LSB = 1.9 \times 10^{-6}$

   Note:

   This value was selected to be a round number near the Minimum_LSB. This section allows for good resolution with a rounded LSB.

5. Compute the calibration register using Equation 13:

$$Cal = trunc\left[\frac{0.04096}{Current\_LSB \times R_{SHUNT}}\right] \quad Cal = 4311$$

(13)

6. Calculate the Power LSB using Equation 14. Equation 14 shows a general formula; because the bus voltage measurement LSB is always 4mV, the power formula reduces to calculate the result.

$$Power\_LSB = 20\ Current\_LSB$$

$$Power\_LSB = 38 \times 10^{-6}$$

(14)

7. Compute the maximum current and shunt voltage values (before overflow), as shown by Equation 15 and Equation 16. Note that both Equation 15 and Equation 16 involve an *If - then* condition.

Max_Current = Current_LSB × 32767

Max_Current = 0.06226 (15)

    If Max_Current ≥ Max Possible_I then

        Max_Current_Before_Overflow = MaxPossible_I

    Else

        Max_Current_Before_Overflow = Max_Current

    End If

    (Note that Max_Current is less than MaxPossible_I in this example.)

    Max_Current_Before_Overflow = 0.06226 (Note: This result is displayed by software as seen in Figure 22.)

Max_ShuntVoltage = Max_Current_Before_Overflow × R_{SHUNT}

Max_ShuntVoltage = 0.3113 (16)

      If Max_ShuntVoltage ≥ V_{SHUNT_MAX}

        Max_ShuntVoltage_Before_Overflow = V_{SHUNT_MAX}

      Else

        Max_ShuntVoltage_Before_Overflow= Max_ShuntVoltage

      End If

      (Note that Max_ShuntVoltage is less than V_{SHUNT_MAX} in this example.)

      Max_ShuntVoltage_Before_Overflow = 0.3113 (Note: This result is displayed by software as seen in Figure 22.)

8. Compute the maximum power with equation 8.

MaximumPower = Max_Current_Before_Overflow × V_{BUS_MAX}

MaximumPower = 1.992 (17)

9. (Optional second calibration step.) Compute the corrected full-scale calibration value based on measured current.

    INA219_Current = 0.06226

    MeaShuntCurrent = 0.05

$$Corrected\_Full\_Scale\_Cal = trunc\left[\frac{Cal \times MeasShuntCurrent}{INA219\_Current}\right]$$

Corrected_Full_Scale_Cal = 3462 (18)

Figure 22 illustrates how to perform the same procedure discussed in this example using the automated INA219EVM software. Note that the same numbers used in the nine-step example are used in the software example in Figure 22. Also note that Figure 22 illustrates which results correspond to which step (for example, the information entered in Step 1 is enclosed in a box in Figure 22 and labeled).
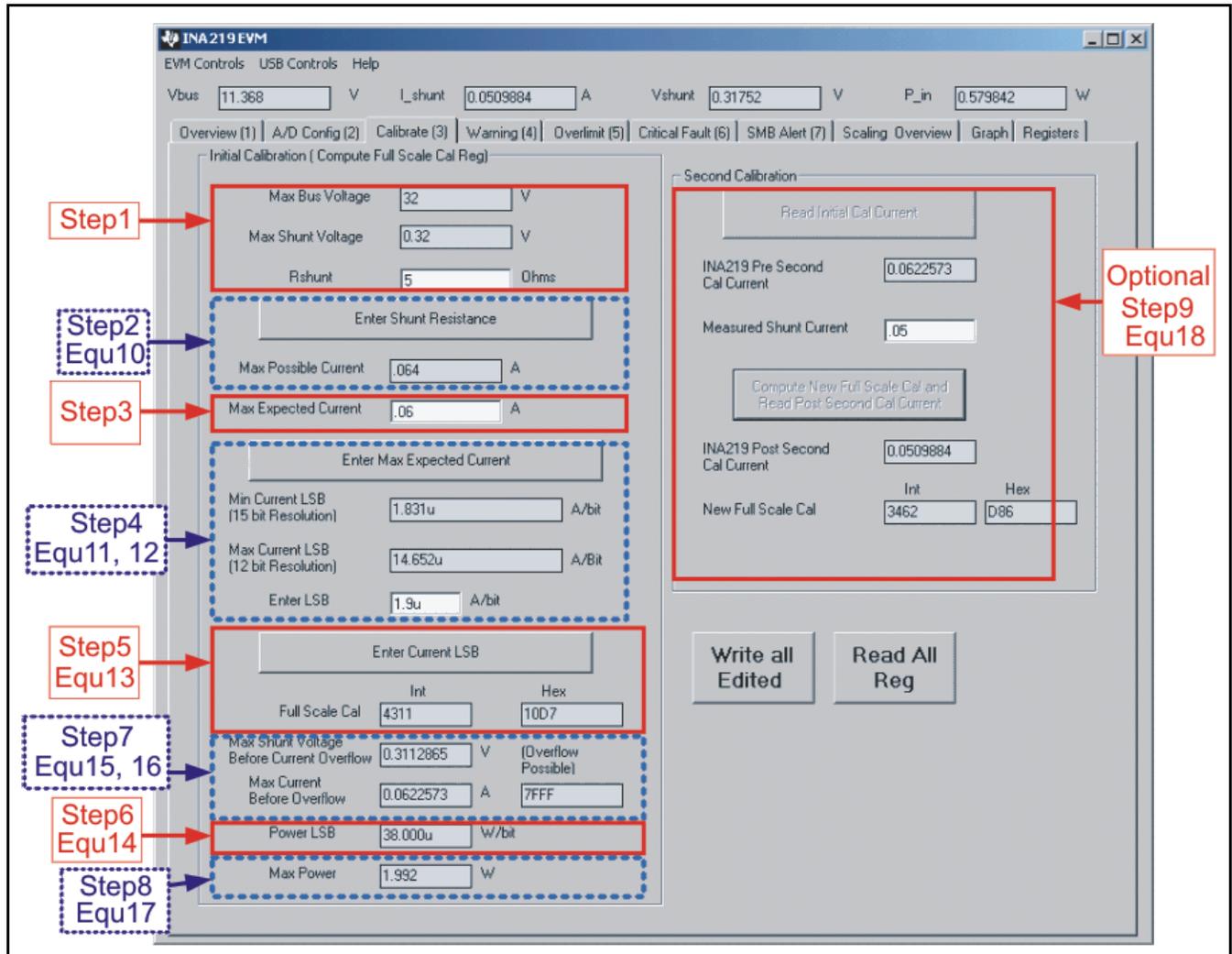
Figure 22. Calibration Software Automatically Computes Calibration Steps 1-9

REGISTER INFORMATION

The INA219 uses a bank of registers for holding configuration settings, measurement results, maximum/minimum limits, and status information. Table 2 summarizes the INA219 registers; Figure 12 illustrates registers.

Register contents are updated 4µs after completion of the write command. Therefore, a 4µs delay is required between completion of a write to a given register and a subsequent read of that register (without changing the pointer) when using SCL frequencies in excess of 1MHz.

Table 2. Summary of Register Set

POINTER ADDRESS	REGISTER NAME	FUNCTION	POWER-ON RESET		TYPE[1]
HEX			BINARY	HEX	
00	Configuration Register	All-register reset, settings for bus voltage range, PGA Gain, ADC resolution/averaging.	00111001 10011111	399F	R/$\overline{\text{W}}$
01	Shunt Voltage	Shunt voltage measurement data.	Shunt voltage	—	R
02	Bus Voltage	Bus voltage measurement data.	Bus voltage	—	R
03	Power[2]	Power measurement data.	00000000 00000000	0000	R
04	Current[2]	Contains the value of the current flowing through the shunt resistor.	00000000 00000000	0000	R
05	Calibration	Sets full-scale range and LSB of current and power measurements. Overall system calibration.	00000000 00000000	0000	R/$\overline{\text{W}}$

(1) Type: **R** = Read-Only, **R/$\overline{\text{W}}$** = Read/Write.
(2) The Power Register and Current Register default to '0' because the Calibration Register defaults to '0', yielding a zero current value until the Calibration Register is programmed.

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INSTRUMENTS

REGISTER DETAILS

All INA219 registers 16-bit registers are actually two 8-bit bytes via the I^{2}C interface.

Configuration Register 00h (Read/Write)

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
BIT NAME	RST	—	BRNG	PG1	PG0	BADC4	BADC3	BADC2	BADC1	SADC4	SADC3	SADC2	SADC1	MODE3	MODE2	MODE1
POR VALUE	0	0	1	1	1	0	0	1	1	0	0	1	1	1	1	1

Bit Descriptions

RST:	**Reset Bit**
Bit 15	Setting this bit to '1' generates a system reset that is the same as power-on reset. Resets all registers to default values; this bit self-clears.
BRNG:	**Bus Voltage Range**
Bit 13	0 = 16V FSR 1 = 32V FSR (default value)
PG:	**PGA (Shunt Voltage Only)**
Bits 11, 12	Sets PGA gain and range. Note that the PGA defaults to ÷8 (320mV range). Table 3 shows the gain and range for the various product gain settings.

Table 3. PG Bit Settings[1]

PG1	PG0	GAIN	RANGE
0	0	1	±40mV
0	1	÷2	±80mV
1	0	÷4	±160mV
1	1	÷8	±320mV

(1) Shaded values are default.

BADC:	**BADC Bus ADC Resolution/Averaging**
Bits 7–10	These bits adjust the Bus ADC resolution (9-, 10-, 11-, or 12-bit) or set the number of samples used when averaging results for the Bus Voltage Register (02h).

SADC:	**SADC Shunt ADC Resolution/Averaging**
Bits 3–6	These bits adjust the Shunt ADC resolution (9-, 10-, 11-, or 12-bit) or set the number of samples used when averaging results for the Shunt Voltage Register (01h).
	BADC (Bus) and SADC (Shunt) ADC resolution/averaging and conversion time settings are shown in Table 4.

Table 4. ADC Settings[1]

ADC4	ADC3	ADC2	ADC1	MODE/SAMPLES	CONVERSION TIME
0	X[2]	0	0	9-bit	84μs
0	X[2]	0	1	10-bit	148μs
0	X[2]	1	0	11-bit	276μs
0	X[2]	1	1	12-bit	532μs
1	0	0	0	12-bit	532μs
1	0	0	1	2	1.06ms
1	0	1	0	4	2.13ms
1	0	1	1	8	4.26ms
1	1	0	0	16	8.51ms
1	1	0	1	32	17.02ms
1	1	1	0	64	34.05ms
1	1	1	1	128	68.10ms

(1)   Shaded values are default.
(2)   X = Don't care.

| MODE: | **Operating Mode** |
| Bits 0–2 | Selects continuous, triggered, or power-down mode of operation. These bits default to continuous shunt and bus measurement mode. The mode settings are shown in Table 5. |

Table 5. Mode Settings[1]

MODE3	MODE2	MODE1	MODE
0	0	0	Power-Down
0	0	1	Shunt Voltage, Triggered
0	1	0	Bus Voltage, Triggered
0	1	1	Shunt and Bus, Triggered
1	0	0	ADC Off (disabled)
1	0	1	Shunt Voltage, Continuous
1	1	0	Bus Voltage, Continuous
1	1	1	Shunt and Bus, Continuous

(1)   Shaded values are default.

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DATA OUTPUT REGISTERS

Shunt Voltage Register 01h (Read-Only)

The Shunt Voltage Register stores the current shunt voltage reading, V_{SHUNT}. Shunt Voltage Register bits are shifted according to the PGA setting selected in the Configuration Register (00h). When multiple sign bits are present, they will all be the same value. Negative numbers are represented in two's complement format. Generate the two's complement of a negative number by complementing the absolute value binary number and adding 1. Extend the sign, denoting a negative number by setting the MSB = '1'. Extend the sign to any additional sign bits to form the 16-bit word.

Example: For a value of V_{SHUNT} = −320mV:

1. Take the absolute value (include accuracy to 0.01mV)==> 320.00
2. Translate this number to a whole decimal number ==> 32000
3. Convert it to binary==> 111 1101 0000 0000
4. Complement the binary result : 000 0010 1111 1111
5. Add 1 to the Complement to create the Two's Complement formatted result ==> 000 0011 0000 0000
6. Extend the sign and create the 16-bit word: 1000 0011 0000 0000 = 8300h (Remember to extend the sign to all sign-bits, as necessary based on the PGA setting.)

At PGA = ÷8, full-scale range = ±320mV (decimal = 32000, positive value hex = 7D00, negative value hex = 8300), and LSB = 10µV.

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
BIT NAME	SIGN	SD14_8	SD13_8	SD12_8	SD11_8	SD10_8	SD9_8	SD8_8	SD7_8	SD6_8	SD5_8	SD4_8	SD3_8	SD2_8	SD1_8	SD0_8
POR VALUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

At PGA = ÷4, full-scale range = ±160mV (decimal = 16000, positive value hex = 3E80, negative value hex = C180), and LSB = 10µV.

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
BIT NAME	SIGN	SIGN	SD13_4	SD12_4	SD11_4	SD10_4	SD9_4	SD8_4	SD7_4	SD6_4	SD5_4	SD4_4	SD3_4	SD2_4	SD1_4	SD0_4
POR VALUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

At PGA = ÷2, full-scale range = ±80mV (decimal = 8000, positive value hex = 1F40, negative value hex = E0C0), and LSB = 10µV.

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
BIT NAME	SIGN	SIGN	SIGN	SD12_2	SD11_2	SD10_2	SD9_2	SD8_2	SD7_2	SD6_2	SD5_2	SD4_2	SD3_2	SD2_2	SD1_2	SD0_2
POR VALUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

At PGA = ÷1, full-scale range = ±40mV (decimal = 4000, positive value hex = 0FA0, negative value hex = F060), and LSB = 10µV.

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
BIT NAME	SIGN	SIGN	SIGN	SIGN	SD11_1	SD10_1	SD9_1	SD8_1	SD7_1	SD6_1	SD5_1	SD4_1	SD3_1	SD2_1	SD1_1	SD0_1
POR VALUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

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Table 6. Shunt Voltage Register Format[1]

V_SHUNT Reading (mV)	Decimal Value	PGA = ÷ 8 (D15…................D0)	PGA = ÷ 4 (D15…................D0)	PGA = ÷ 2 (D15…................D0)	PGA = ÷ 1 (D15…................D0)
320.02	32002	0111 1101 0000 0000	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
320.01	32001	0111 1101 0000 0000	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
320.00	32000	0111 1101 0000 0000	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
319.99	31999	0111 1100 1111 1111	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
319.98	31998	0111 1100 1111 1110	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
⋮	⋮	⋮	⋮	⋮	⋮
160.02	16002	0011 1110 1000 0010	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
160.01	16001	0011 1110 1000 0001	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
160.00	16000	0011 1110 1000 0000	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
159.99	15999	0011 1110 0111 1111	0011 1110 0111 1111	0001 1111 0100 0000	0000 1111 1010 0000
159.98	15998	0011 1110 0111 1110	0011 1110 0111 1110	0001 1111 0100 0000	0000 1111 1010 0000
⋮	⋮	⋮	⋮	⋮	⋮
80.02	8002	0001 1111 0100 0010	0001 1111 0100 0010	0001 1111 0100 0000	0000 1111 1010 0000
80.01	8001	0001 1111 0100 0001	0001 1111 0100 0001	0001 1111 0100 0000	0000 1111 1010 0000
80.00	8000	0001 1111 0100 0000	0001 1111 0100 0000	0001 1111 0100 0000	0000 1111 1010 0000
79.99	7999	0001 1111 0011 1111	0001 1111 0011 1111	0001 1111 0011 1111	0000 1111 1010 0000
79.98	7998	0001 1111 0011 1110	0001 1111 0011 1110	0001 1111 0011 1110	0000 1111 1010 0000
⋮	⋮	⋮	⋮	⋮	⋮
40.02	4002	0000 1111 1010 0010	0000 1111 1010 0010	0000 1111 1010 0010	0000 1111 1010 0000
40.01	4001	0000 1111 1010 0001	0000 1111 1010 0001	0000 1111 1010 0001	0000 1111 1010 0000
40.00	4000	0000 1111 1010 0000	0000 1111 1010 0000	0000 1111 1010 0000	0000 1111 1010 0000
39.99	3999	0000 1111 1001 1111	0000 1111 1001 1111	0000 1111 1001 1111	0000 1111 1001 1111
39.98	3998	0000 1111 1001 1110	0000 1111 1001 1110	0000 1111 1001 1110	0000 1111 1001 1110
⋮	⋮	⋮	⋮	⋮	⋮
0.02	2	0000 0000 0000 0010	0000 0000 0000 0010	0000 0000 0000 0010	0000 0000 0000 0010
0.01	1	0000 0000 0000 0001	0000 0000 0000 0001	0000 0000 0000 0001	0000 0000 0000 0001
0	0	0000 0000 0000 0000	0000 0000 0000 0000	0000 0000 0000 0000	0000 0000 0000 0000
−0.01	−1	1111 1111 1111 1111	1111 1111 1111 1111	1111 1111 1111 1111	1111 1111 1111 1111
−0.02	−2	1111 1111 1111 1110	1111 1111 1111 1110	1111 1111 1111 1110	1111 1111 1111 1110
⋮	⋮	⋮	⋮	⋮	⋮
−39.98	−3998	1111 0000 0110 0010	1111 0000 0110 0010	1111 0000 0110 0010	1111 0000 0110 0010
−39.99	−3999	1111 0000 0110 0001	1111 0000 0110 0001	1111 0000 0110 0001	1111 0000 0110 0001
−40.00	−4000	1111 0000 0110 0000	1111 0000 0110 0000	1111 0000 0110 0000	1111 0000 0110 0000
−40.01	−4001	1111 0000 0101 1111	1111 0000 0101 1111	1111 0000 0101 1111	1111 0000 0110 0000
−40.02	−4002	1111 0000 0101 1110	1111 0000 0101 1110	1111 0000 0101 1110	1111 0000 0110 0000
⋮	⋮	⋮	⋮	⋮	⋮
−79.98	−7998	1110 0000 1100 0010	1110 0000 1100 0010	1110 0000 1100 0010	1111 0000 0110 0000
−79.99	−7999	1110 0000 1100 0001	1110 0000 1100 0001	1110 0000 1100 0001	1111 0000 0110 0000
−80.00	−8000	1110 0000 1100 0000	1110 0000 1100 0000	1110 0000 1100 0000	1111 0000 0110 0000
−80.01	−8001	1110 0000 1011 1111	1110 0000 1011 1111	1110 0000 1100 0000	1111 0000 0110 0000
−80.02	−8002	1110 0000 1011 1110	1110 0000 1011 1110	1110 0000 1100 0000	1111 0000 0110 0000
⋮	⋮	⋮	⋮	⋮	⋮
−159.98	−15998	1100 0001 1000 0010	1100 0001 1000 0010	1110 0000 1100 0000	1111 0000 0110 0000
−159.99	−15999	1100 0001 1000 0001	1100 0001 1000 0001	1110 0000 1100 0000	1111 0000 0110 0000
−160.00	−16000	1100 0001 1000 0000	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
−160.01	−16001	1100 0001 0111 1111	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
−160.02	−16002	1100 0001 0111 1110	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
⋮	⋮	⋮	⋮	⋮	⋮
−319.98	−31998	1000 0011 0000 0010	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
−319.99	−31999	1000 0011 0000 0001	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
−320.00	−32000	1000 0011 0000 0000	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
−320.01	−32001	1000 0011 0000 0000	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
−320.02	−32002	1000 0011 0000 0000	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000

(1) Out-of-range values are shown in grey shading.

Bus Voltage Register 02h (Read-Only)

The Bus Voltage Register stores the most recent bus voltage reading, V_{BUS}.

At full-scale range = 32V (decimal = 8000, hex = 1F40), and LSB = 4mV.

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
BIT NAME	BD12	BD11	BD10	BD9	BD8	BD7	BD6	BD5	BD4	BD3	BD2	BD1	BD0	—	CNVR	OVF
POR VALUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

At full-scale range = 16V (decimal = 4000, hex = 0FA0), and LSB = 4mV.

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
BIT NAME	0	BD11	BD10	BD9	BD8	BD7	BD6	BD5	BD4	BD3	BD2	BD1	BD0	—	CNVR	OVF
POR VALUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

CNVR: **Conversion Ready**

Bit 1   Although the data from the last conversion can be read at any time, the INA219 Conversion Ready bit (CNVR) indicates when data from a conversion is available in the data output registers. The CNVR bit is set after all conversions, averaging, and multiplications are complete. CNVR will clear under the following conditions:

1.) Writing a new mode into the Operating Mode bits in the Configuration Register (except for Power-Down or Disable)

2.) Reading the Power Register

OVF: **Math Overflow Flag**

Bit 0   The Math Overflow Flag (OVF) is set when the Power or Current calculations are out of range. It indicates that current and power data may be meaningless.

Power Register 03h (Read-Only)

Full-scale range and LSB are set by the Calibration Register. See the *Programming the INA219 Power Measurement Engine* section.

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
BIT NAME	PD15	PD14	PD13	PD12	PD11	PD10	PD9	PD8	PD7	PD6	PD5	PD4	PD3	PD2	PD1	PD0
POR VALUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

The Power Register records power in watts by multiplying the values of the current with the value of the bus voltage according to the equation:

$$Power = \frac{Current \times BusVoltage}{5000}$$

Current Register 04h (Read-Only)

Full-scale range and LSB depend on the value entered in the Calibration Register. See the *Programming the INA219 Power Measurement Engine* section. Negative values are stored in two's complement format.

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
BIT NAME	CSIGN	CD14	CD13	CD12	CD11	CD10	CD9	CD8	CD7	CD6	CD5	CD4	CD3	CD2	CD1	CD0
POR VALUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

The value of the Current Register is calculated by multiplying the value in the Shunt Voltage Register with the value in the Calibration Register according to the equation:

$$Current = \frac{ShuntVoltage \times Calibration\ Register}{4096}$$

CALIBRATION REGISTER

Calibration Register 05h (Read/Write)

Current and power calibration are set by bits D15 to D1 of the Calibration Register. Note that bit D0 is not used in the calculation. This register sets the current that corresponds to a full-scale drop across the shunt. Full-scale range and the LSB of the current and power measurement depend on the value entered in this register. See the *Programming the INA219 Power Measurement Engine* section. This register is suitable for use in overall system calibration. Note that the '0' POR values are all default.

BIT #	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0[1]
BIT NAME	FS15	FS14	FS13	FS12	FS11	FS10	FS9	FS8	FS7	FS6	FS5	FS4	FS3	FS2	FS1	FS0
POR VALUE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

(1)   D0 is a *void* bit and will always be '0'. It is not possible to write a '1' to D0. CALIBRATION is the value stored in D15:D1.

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
INA219AID	PREVIEW	SOIC	D	8	75	TBD	Call TI	Call TI
INA219AIDCNR	ACTIVE	SOT-23	DCN	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
INA219AIDCNRG4	ACTIVE	SOT-23	DCN	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
INA219AIDCNT	ACTIVE	SOT-23	DCN	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
INA219AIDCNTG4	ACTIVE	SOT-23	DCN	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
INA219AIDR	PREVIEW	SOIC	D	8	2500	TBD	Call TI	Call TI

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

D (R−PDSO−G8)   PLASTIC SMALL−OUTLINE PACKAGE

0.197 (5,00)
0.189 (4,80)
△C

8   5

0.244 (6,20)
0.228 (5,80)

0.157 (4,00)
0.150 (3,80)   △D

Pin 1
Index Area

1   4

0.050 (1,27)

0.020 (0,51)
0.012 (0,31)

⊕ 0.010 (0,25) Ⓜ

0.069 (1,75) Max

0.010 (0,25)
0.004 (0,10)

0.010 (0,25)
0.005 (0,13)

Gauge Plane

0.004 (0,10)

Seating Plane

0.010 (0,25)   0°−8°

0.050 (1,27)
0.016 (0,40)

4040047−2/I 10/2008

NOTES: A. All linear dimensions are in inches (millimeters).
        B. This drawing is subject to change without notice.
        △C Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall
            not exceed .006 (0,15) per end.
        △D Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
        E. Reference JEDEC MS−012 variation AA.

TEXAS INSTRUMENTS
www.ti.com

DCN (R–PDSO–G8)   PLASTIC SMALL–OUTLINE PACKAGE (DIE DOWN)

$\frac{3,00}{2,80}$

$\frac{3,00}{2,60}$

$\frac{1,75}{1,45}$

8

5

1

4

Pin 1
Index Area

0,65

1,95

8X $\frac{0,38}{0,22}$

⊕ | 0,13 Ⓜ

$\frac{0,22}{0,08}$

Gauge Plane

Seating Plane

0,25

0°–8°

$\frac{0,60}{0,30}$

$\frac{1,30}{0,90}$

$\frac{1,45}{0,90}$

$\frac{0,15}{0,00}$

⌂ | 0,10

Seating Plane

4202106/C 07/2006
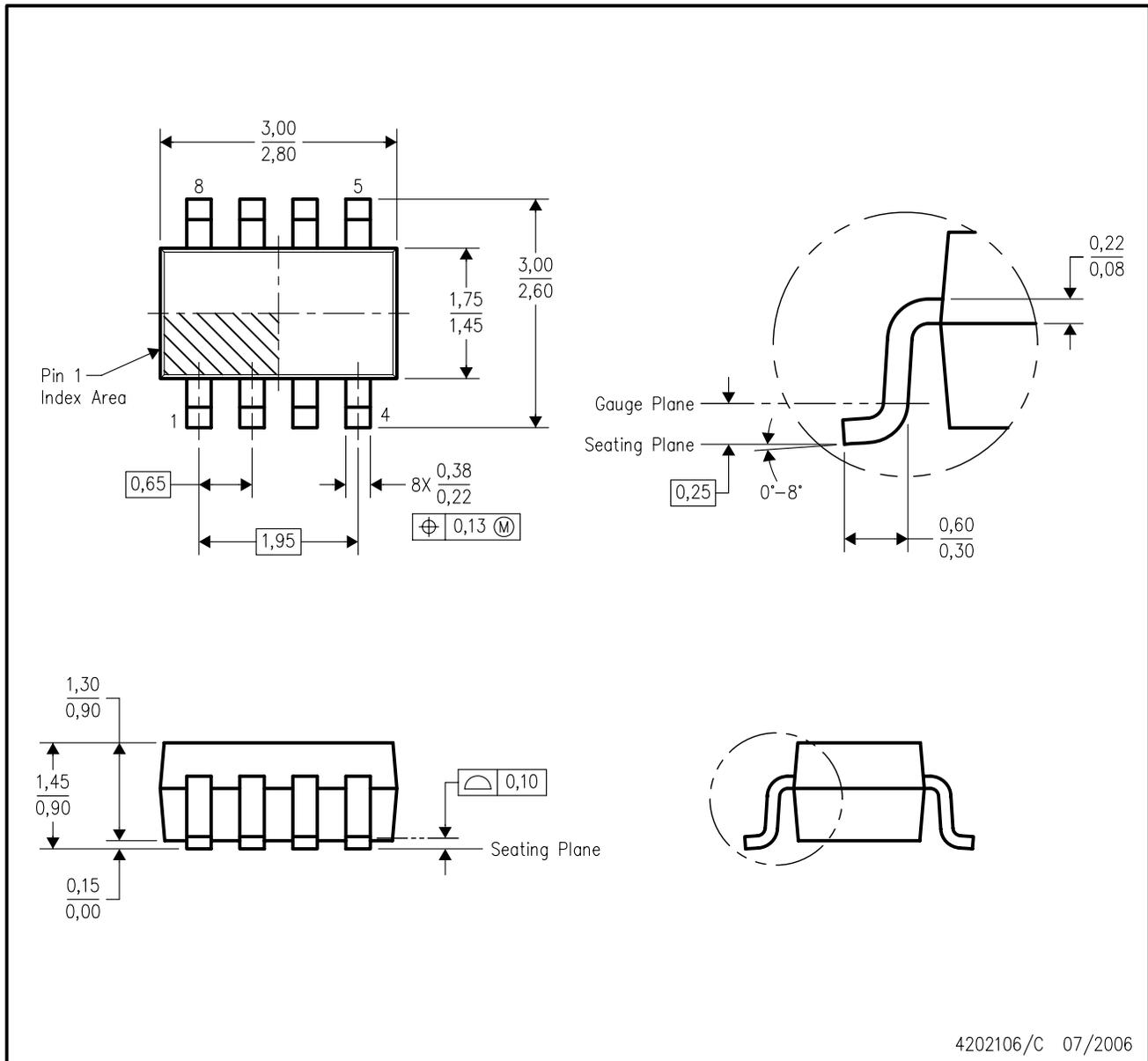
NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Package outline exclusive of mold flash, metal burr & dambar protrusion/intrusion.
D. Package outline inclusive of solder plating.
E. A visual index feature must be located within the Pin 1 index area.
F. Falls within JEDEC MO–178 Variation BA.

IMPORTANT NOTICE